

Please add claims 13-20 as follows:

*AB*  
--13. (Amended) An SAW filter device including an SAW filter according to claim 2, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

14. (Amended) An SAW filter device including an SAW filter according to claim 3, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

15. (Amended) An SAW filter device including an SAW filter according to claim 4, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

16. (Amended) An SAW filter device including an SAW filter according to claim 5, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip

2000P342686

substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

*A3  
cont*

17. (Amended) An SAW filter device including an SAW filter according to claim 6, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

18. (Amended) An SAW filter device including an SAW filter according to claim 7, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

19. (Amended) An SAW filter device including an SAW filter according to claim 8, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.

20. (Amended) An SAW filter device including an SAW filter according to claim 9, which comprises a plastic package including a terminal member made of metal extending out of the

2000P342686

package and extending into the package such as to form an L-shaped portion, the chip  
substrate being accommodated in the plastic package such that the back surface of the chip  
substrate is in contact with the L-shaped portion. --

A3  
Concl.

00000000000000000000000000000000